Structural characterization of Si/SiO₂ quantum wells by HRTEM for the solar cell application

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We investigate the structural properties of Si/SiO_2 multilayers for high-efficiency solar cells by means of high resolution transmission electron microscope (HRTEM). The analysis has been done by a FEI Titan 80-300 TEM equipped with Cs corrector and operating at 300 keV. Si/SiO_2 multiple quantum wells were prepared by plasma enhanced chemical vapour deposition (PRECVD) and then processed by rapid thermal annealing for Si recrystallization. To prepare a Si/SiO2 quantum well sample for cross-sectional TEM analysis, a focused ion beam (FIB) instrument was used to cut a slice through the sample and to thin the interface. The sample was further thinned with a *Fischione* model 1040 NanoMill, which removes the surface damage introduced by the initial FIB sectioning and finally cleaned by a plasma cleaning system.

It has been shown recently that the layer thickness and interface modification have considerable impact on the optical properties of this structure [1]. Therefore precise structural characterization methods like HRTEM have promoted our understanding of this Si-based tandem structure. TEM images, taken in the negative spherical-aberration imaging (NCSI) condition [2], successfully reveal the structure of the nano-crystals. Also further thinning of the sample by nanomilling technique helps to see more details by HRTEM analysis.

The HRTEM observations revealed the presence of continous nano-crystalline Si quantumwell layers with a thickness of about 4 nm encapsulated between 2 nm thick layers of amorphous SiO_2 (see figure 1). The resulting Si quantum wells are completely polycrystalline, which could be verified by imaging either the Si(220) or Si(111) lattice planes in all nano-crystals.

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